

## C2225X473MDRALTU

Aliases (C2225X473MDRAL7800)

SMD Comm X7R HV Flex, Ceramic, 0.047 uF, 20%, 1,000 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 2225, 3.2 mm



Click [here](#) for the 3D model.

### General Information

Series	SMD Comm X7R HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	No
Prop 65	<b>WARNING:</b> Cancer and reproductive harm - <a href="https://www.p65warnings.ca.gov/">https://www.p65warnings.ca.gov/</a>
SCIP Number	724b81dc-0c36-4aa3-aabc-63f2cc6f8822
Termination	Flexible Termination With Lead (SnPb)
Marking	No
AEC-Q200	No
Typical Component Weight	430 mg
Shelf Life	78 Weeks
MSL	1

### Dimensions

Chip Size	2225
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
T	1.6mm +/-0.20mm
S	3.2mm MIN
B	0.7mm +/-0.35mm

### Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

### Specifications

Capacitance	0.047 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	21.2766 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.